IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

INFORMATION SHEET

Applicants:

YONG-KWAN LEE and TAE-DUK NAM

Application No.:

NEW

Filed:

January 29, 2004

For:

FLIP CHIP PACKAGE HAVING PROTECTIVE CAP AND

METHOD OF FABRICATING THE SAME

Priority Claimed Under 35 U.S.C. §119 and/or 120:

COUNTRY

DATE

NUMBER

REPUBLIC OF KOREA

January 29, 2003

10-2003-0005936

Send correspondence to:

HARNESS, DICKEY & PIERCE, P.L.C.

P.O. Box 8910 Reston, VA 20195 (703) 668-8000

The above information is submitted to advise the United States Patent and Trademark Office of all relevant facts in connection with the present application. A timely executed Declaration in accordance with 37 CFR 1.64 will follow.

Respectfully submitted,

By

ohn A. Castellano, Reg. No. 35,094

P.O. Box 8910 Reston, VA 20195 (703) 668-8000

JAC:ji

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

YONG-KWAN LEE and TAE-DUK NAM

Application No.:

NEW

Filed:

January 29, 2004

For: FLIP CHIP PACKAGE HAVING PROTECTIVE CAP AND METHOD OF

FABRICATING THE SAME

PRIORITY LETTER

January 29, 2004

COMMISSIONER FOR PATENTS P.O. BOX 1450 Alexandria, Virginia 22313-1450

Dear Sirs:

Pursuant to the provisions of 35 U.S.C. 119, enclosed is/are a certified copy of the following priority document(s).

Application No.

Date Filed

Country

10-2003-0005936

January 29, 2003

REPUBLIC OF KOREA

In support of Applicant's priority claim, please enter this document into the file.

Respectfully submitted,

HARNESS, DICKEY, & PIERCE, P.L.C.

Ву

John A. Castellano, Reg. No. 35,094

D. Box 8910

Reston, Virginia 20195

4703) 668-8000

JAC: jj